

31046 U.S. PTO
10/029991
12/31/01

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10029991	FILING DATE 12/31/2001	CLASS 528	SUBCLASS 528	GAU 1712	EXAMINER ZIMMER
**APPLICANTS: Hashimoto Takeshi; Kobayashi Masaharu; Sato Takeshi; Orino Daisuke;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A DIV OF 09/433,281 11/03/1999 PAT 6,346,598					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 331977/98 11/06/1998 JAPAN 331978/98 11/06/1998 JAPAN 331979/98 11/06/1998					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO 2001-1790	
TITLE : Thermosetting low-dielectric resin composition and use thereof <small>U.S. DEPT. OF COMM/PAT & TM, PTO-435L (Rev. 12-94)</small>					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner	
		Application Examiner	
		PREPARED FOR ISSUE	
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